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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	35
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f914-i-p

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

2.2.2.4 PIE1 Register

The PIE1 register contains the interrupt enable bits, as shown in Register 2-4.

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt.

REGISTER 2-4: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0 R/W-0	
EEIE	ADIE RCIE		TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

Legend:									
R = Readable bit W =		W = Writable bit	U = Unimplemented bit,	read as '0'					
-n = Value a	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					
bit 7	EEIE. CO	Write Complete Interrupt F	nahla hit						
		E Write Complete Interrupt En les the EE write complete in							
		bles the EE write complete in	•						
bit 6		D Converter (ADC) Interrupt							
	1 = Enab	1 = Enables the ADC interrupt							
	0 = Disat	oles the ADC interrupt							
bit 5	RCIE: US	SART Receive Interrupt Enal	ble bit						
		1 = Enables the USART receive interrupt							
		bles the USART receive inter	-						
bit 4		SART Transmit Interrupt Ena							
		les the USART transmit inte							
h:1 0		bles the USART transmit inte							
bit 3		Synchronous Serial Port (SSI	P) Interrupt Enable bit						
		 1 = Enables the SSP interrupt 0 = Disables the SSP interrupt 							
bit 2		CCP1 Interrupt Enable bit							
		les the CCP1 interrupt							
		oles the CCP1 interrupt							
bit 1	TMR2IE: TMR2 to PR2 Match Interrupt Enable bit								
	1 = Enab	les the Timer2 to PR2 match	n interrupt						
	0 = Disat	oles the Timer2 to PR2 matc	h interrupt						
bit 0		Timer1 Overflow Interrupt E							
		les the Timer1 overflow inter	•						
	0 = Disat	bles the Timer1 overflow inte	rrupt						

3.0 I/O PORTS

The PIC16F913/914/916/917/946 family of devices includes several 8-bit PORT registers along with their corresponding TRIS registers and one four bit port:

- PORTA and TRISA
- PORTB and TRISB
- PORTC and TRISC
- PORTD and TRISD⁽¹⁾
- PORTE and TRISE
- PORTF and TRISF⁽²⁾
- PORTG and TRISG⁽²⁾

Note 1: PIC16F914/917 and PIC16F946 only.

2: PIC16F946 only

PORTA, PORTB, PORTC and RE3/MCLR/VPP are implemented on all devices. PORTD and RE<2:0> (PORTE) are implemented only on the PIC16F914/917 and PIC16F946. RE<7:4> (PORTE), PORTF and PORTG are implemented only on the PIC16F946.

3.1 ANSEL Register

The ANSEL register (Register 3-1) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSEL bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSEL bits has no affect on digital output functions. A pin with TRIS clear and ANSEL set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

REGISTER 3-1: ANSEL: ANALOG SELECT REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANS7 ⁽²⁾	ANS6 ⁽²⁾	ANS6 ⁽²⁾ ANS5 ⁽²⁾		ANS3	ANS2	ANS1	ANS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ANS<7:0>: Analog Select bits

Analog select between analog or digital function on pins AN<7:0>, respectively.

1 = Analog input. Pin is assigned as analog input⁽¹⁾.

- 0 = Digital I/O. Pin is assigned to port or special function.
- **Note 1:** Setting a pin to an analog input automatically disables the digital input circuitry, weak pull-ups, and interrupt-on-change if available. The corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.
 - 2: PIC16F914/PIC16F917/PIC16F946 only.

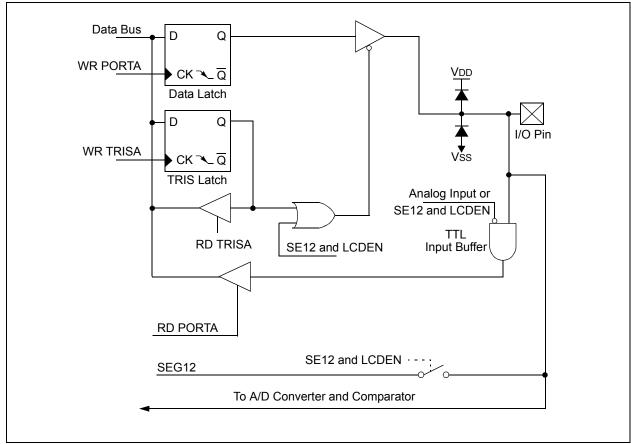
3.2.1 PIN DESCRIPTIONS AND DIAGRAMS

Each PORTA pin is multiplexed with other functions. The pins and their combined functions are briefly described here. For specific information about individual functions, refer to the appropriate section in this data sheet.

3.2.1.1 RA0/AN0/C1-/SEG12

Figure 3-1 shows the diagram for this pin. The RA0 pin is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC
- an analog input for Comparator C1
- an analog output for the LCD



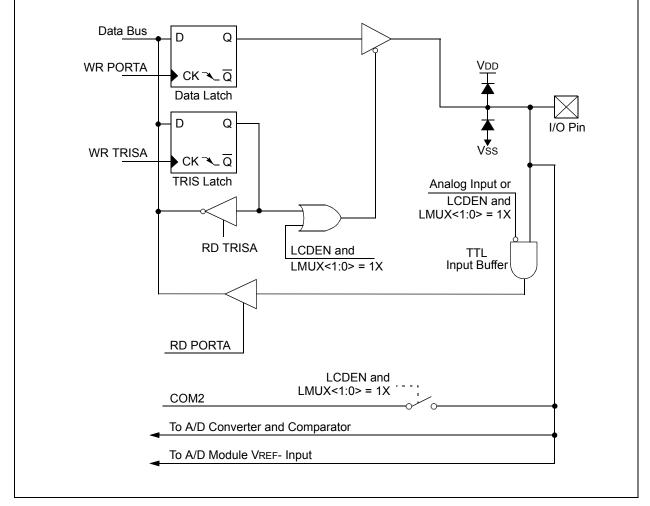


3.2.1.3 RA2/AN2/C2+/VREF-/COM2

Figure 3-3 shows the diagram for this pin. The RA2 pin is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC
- an analog input for Comparator C2
- a voltage reference input for the ADC
- an analog output for the LCD





4.2 Oscillator Control

The Oscillator Control (OSCCON) register (Figure 4-1) controls the system clock and frequency selection options. The OSCCON register contains the following bits:

- Frequency selection bits (IRCF)
- Frequency Status bits (HTS, LTS)
- System clock control bits (OSTS, SCS)

REGISTER 4-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R/W-1 R/W-1		R/W-0 R-1		R-0	R-0	R/W-0
—	IRCF2	IRCF1	IRCF0	OSTS ⁽¹⁾	HTS	LTS	SCS
bit 7							bit 0

Legend:						
R = Readable bit	W = Writable bit	e bit U = Unimplemented bit, read as '0'				
-n = Value at POR	Value at POR '1' = Bit is set		x = Bit is unknown			

bit 7	Unimplemented: Read as '0'
bit 6-4	IRCF<2:0>: Internal Oscillator Frequency Select bits
	111 = 8 MHz
	110 = 4 MHz (default)
	101 = 2 MHz
	100 = 1 MHz
	011 = 500 kHz
	010 = 250 kHz
	001 = 125 kHz
	000 = 31 kHz (LFINTOSC)
bit 3	OSTS: Oscillator Start-up Time-out Status bit ⁽¹⁾
	 1 = Device is running from the clock defined by FOSC<2:0> of the Configuration Word 0 = Device is running from the internal oscillator (HFINTOSC or LFINTOSC)
bit 2	HTS: HFINTOSC Status bit (High Frequency – 8 MHz to 125 kHz)
	1 = HFINTOSC is stable
	0 = HFINTOSC is not stable
bit 1	LTS: LFINTOSC Stable bit (Low Frequency – 31 kHz)
	1 = LFINTOSC is stable
	0 = LFINTOSC is not stable
bit 0	SCS: System Clock Select bit
	1 = Internal oscillator is used for system clock
	 Clock source defined by FOSC<2:0> of the Configuration Word
Note 1	Dit reports to 'o' with Two Speed Start up and LD VT or US selected as the Oscillator mode or Eail Sc

Note 1: Bit resets to '0' with Two-Speed Start-up and LP, XT or HS selected as the Oscillator mode or Fail-Safe mode is enabled.

4.4.3 LP, XT, HS MODES

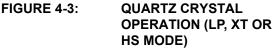
The LP, XT and HS modes support the use of quartz crystal resonators or ceramic resonators connected to OSC1 and OSC2 (Figure 4-3). The mode selects a low, medium or high gain setting of the internal inverter-amplifier to support various resonator types and speed.

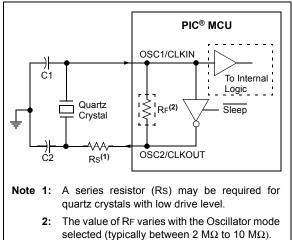
LP Oscillator mode selects the lowest gain setting of the internal inverter-amplifier. LP mode current consumption is the least of the three modes. This mode is designed to drive only 32.768 kHz tuning-fork type crystals (watch crystals).

XT Oscillator mode selects the intermediate gain setting of the internal inverter-amplifier. XT mode current consumption is the medium of the three modes. This mode is best suited to drive resonators with a medium drive level specification.

HS Oscillator mode selects the highest gain setting of the internal inverter-amplifier. HS mode current consumption is the highest of the three modes. This mode is best suited for resonators that require a high drive setting.

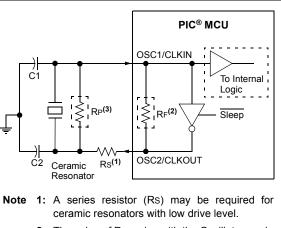
Figure 4-3 and Figure 4-4 show typical circuits for quartz crystal and ceramic resonators, respectively.





- Note 1: Quartz crystal characteristics vary according to type, package and manufacturer. The user should consult the manufacturer data sheets for specifications and recommended application.
 - **2:** Always verify oscillator performance over the VDD and temperature range that is expected for the application.
 - **3:** For oscillator design assistance, reference the following Microchip Applications Notes:
 - AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC[®] and PIC[®] Devices" (DS00826)
 - AN849, "Basic PIC[®] Oscillator Design" (DS00849)
 - AN943, "Practical PIC[®] Oscillator Analysis and Design" (DS00943)
 - AN949, "Making Your Oscillator Work" (DS00949)





- 2: The value of RF varies with the Oscillator mode selected (typically between 2 M Ω to 10 M Ω).
- **3:** An additional parallel feedback resistor (RP) may be required for proper ceramic resonator operation.

4.6 Clock Switching

The system clock source can be switched between external and internal clock sources via software using the System Clock Select (SCS) bit of the OSCCON register.

4.6.1 SYSTEM CLOCK SELECT (SCS) BIT

The System Clock Select (SCS) bit of the OSCCON register selects the system clock source that is used for the CPU and peripherals.

- When the SCS bit of the OSCCON register = 0, the system clock source is determined by configuration of the FOSC<2:0> bits in the Configuration Word register (CONFIG).
- When the SCS bit of the OSCCON register = 1, the system clock source is chosen by the internal oscillator frequency selected by the IRCF<2:0> bits of the OSCCON register. After a Reset, the SCS bit of the OSCCON register is always cleared.
- Note: Any automatic clock switch, which may occur from Two-Speed Start-up or Fail-Safe Clock Monitor, does not update the SCS bit of the OSCCON register. The user can monitor the OSTS bit of the OSCCON register to determine the current system clock source.

4.6.2 OSCILLATOR START-UP TIME-OUT STATUS (OSTS) BIT

The Oscillator Start-up Time-out Status (OSTS) bit of the OSCCON register indicates whether the system clock is running from the external clock source, as defined by the FOSC<2:0> bits in the Configuration Word register (CONFIG), or from the internal clock source. In particular, OSTS indicates that the Oscillator Start-up Timer (OST) has timed out for LP, XT or HS modes.

4.7 Two-Speed Clock Start-up Mode

Two-Speed Start-up mode provides additional power savings by minimizing the latency between external oscillator start-up and code execution. In applications that make heavy use of the Sleep mode, Two-Speed Start-up will remove the external oscillator start-up time from the time spent awake and can reduce the overall power consumption of the device.

This mode allows the application to wake-up from Sleep, perform a few instructions using the INTOSC as the clock source and go back to Sleep without waiting for the primary oscillator to become stable.

Note: Executing a SLEEP instruction will abort the oscillator start-up time and will cause the OSTS bit of the OSCCON register to remain clear. When the Oscillator module is configured for LP, XT or HS modes, the Oscillator Start-up Timer (OST) is enabled (see **Section 4.4.1 "Oscillator Start-up Timer (OST)"**). The OST will suspend program execution until 1024 oscillations are counted. Two-Speed Start-up mode minimizes the delay in code execution by operating from the internal oscillator as the OST is counting. When the OST count reaches 1024 and the OSTS bit of the OSCCON register is set, program execution switches to the external oscillator.

4.7.1 TWO-SPEED START-UP MODE CONFIGURATION

Two-Speed Start-up mode is configured by the following settings:

- IESO (of the Configuration Word register) = 1; Internal/External Switchover bit (Two-Speed Start-up mode enabled).
- SCS (of the OSCCON register) = 0.
- FOSC<2:0> bits in the Configuration Word register (CONFIG) configured for LP, XT or HS mode.

Two-Speed Start-up mode is entered after:

- Power-on Reset (POR) and, if enabled, after Power-up Timer (PWRT) has expired, or
- Wake-up from Sleep.

If the external clock oscillator is configured to be anything other than LP, XT or HS mode, then Two-Speed Start-up is disabled. This is because the external clock oscillator does not require any stabilization time after POR or an exit from Sleep.

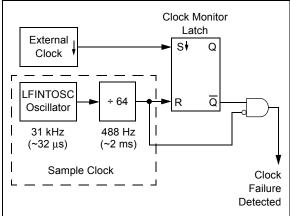
4.7.2 TWO-SPEED START-UP SEQUENCE

- 1. Wake-up from Power-on Reset or Sleep.
- Instructions begin execution by the internal oscillator at the frequency set in the IRCF<2:0> bits of the OSCCON register.
- 3. OST enabled to count 1024 clock cycles.
- 4. OST timed out, wait for falling edge of the internal oscillator.
- 5. OSTS is set.
- 6. System clock held low until the next falling edge of new clock (LP, XT or HS mode).
- 7. System clock is switched to external clock source.

4.8 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the device to continue operating should the external oscillator fail. The FSCM can detect oscillator failure any time after the Oscillator Start-up Timer (OST) has expired. The FSCM is enabled by setting the FCMEN bit in the Configuration Word register (CONFIG). The FSCM is applicable to all external oscillator modes (LP, XT, HS, EC, RC and RCIO).

FIGURE 4-8: FSCM BLOCK DIAGRAM



4.8.1 FAIL-SAFE DETECTION

The FSCM module detects a failed oscillator by comparing the external oscillator to the FSCM sample clock. The sample clock is generated by dividing the LFINTOSC by 64. See Figure 4-8. Inside the fail detector block is a latch. The external clock sets the latch on each falling edge of the external clock. The sample clock clears the latch on each rising edge of the sample clock. A failure is detected when an entire half-cycle of the sample clock elapses before the primary clock goes low.

4.8.2 FAIL-SAFE OPERATION

When the external clock fails, the FSCM switches the device clock to an internal clock source and sets the bit flag OSFIF of the PIR2 register. Setting this flag will generate an interrupt if the OSFIE bit of the PIE2 register is also set. The device firmware can then take steps to mitigate the problems that may arise from a failed clock. The system clock will continue to be sourced from the internal clock source until the device firmware successfully restarts the external oscillator and switches back to external operation.

The internal clock source chosen by the FSCM is determined by the IRCF<2:0> bits of the OSCCON register. This allows the internal oscillator to be configured before a failure occurs.

4.8.3 FAIL-SAFE CONDITION CLEARING

The Fail-Safe condition is cleared after a Reset, executing a SLEEP instruction or toggling the SCS bit of the OSCCON register. When the SCS bit is toggled, the OST is restarted. While the OST is running, the device continues to operate from the INTOSC selected in OSCCON. When the OST times out, the Fail-Safe condition is cleared and the device will be operating from the external clock source. The Fail-Safe condition must be cleared before the OSFIF flag can be cleared.

4.8.4 RESET OR WAKE-UP FROM SLEEP

The FSCM is designed to detect an oscillator failure after the Oscillator Start-up Timer (OST) has expired. The OST is used after waking up from Sleep and after any type of Reset. The OST is not used with the EC or RC Clock modes so that the FSCM will be active as soon as the Reset or wake-up has completed. When the FSCM is enabled, the Two-Speed Start-up is also enabled. Therefore, the device will always be executing code while the OST is operating.

Note: Due to the wide range of oscillator start-up times, the Fail-Safe circuit is not active during oscillator start-up (i.e., after exiting Reset or Sleep). After an appropriate amount of time, the user should check the OSTS bit of the OSCCON register to verify the oscillator start-up and that the system clock switchover has successfully completed.

FIGURE 4-9: FSCM TIMING DIAGRAM

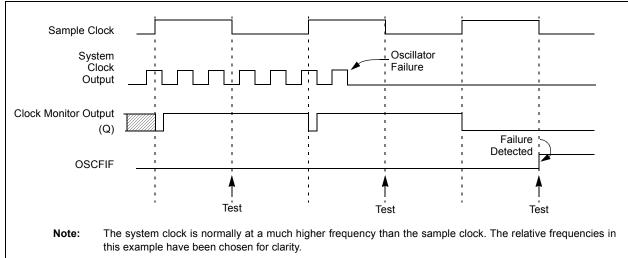


TABLE 4-2:	SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets ⁽¹⁾
CONFIG ⁽²⁾	CPD	CP	MCLRE	PWRTE	WDTE	FOSC2	FOSC1	FOSC0	_	_
INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000x
OSCCON	_	IRCF2	IRCF1	IRCF0	OSTS	HTS	LTS	SCS	-110 x000	-110 x000
OSCTUNE	_	—	—	TUN4	TUN3	TUN2	TUN1	TUN0	0 0000	u uuuu
PIE2	OSFIE	C2IE	C1IE	LCDIE	_	LVDIE	_	CCP2IE	0000 -0-0	0000 -0-0
PIR2	OSFIF	C2IF	C1IF	LCDIF	_	LVDIF		CCP2IF	0000 -0-0	0000 -0-0
T1CON	T1GINV	TMR1GE	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by oscillators.

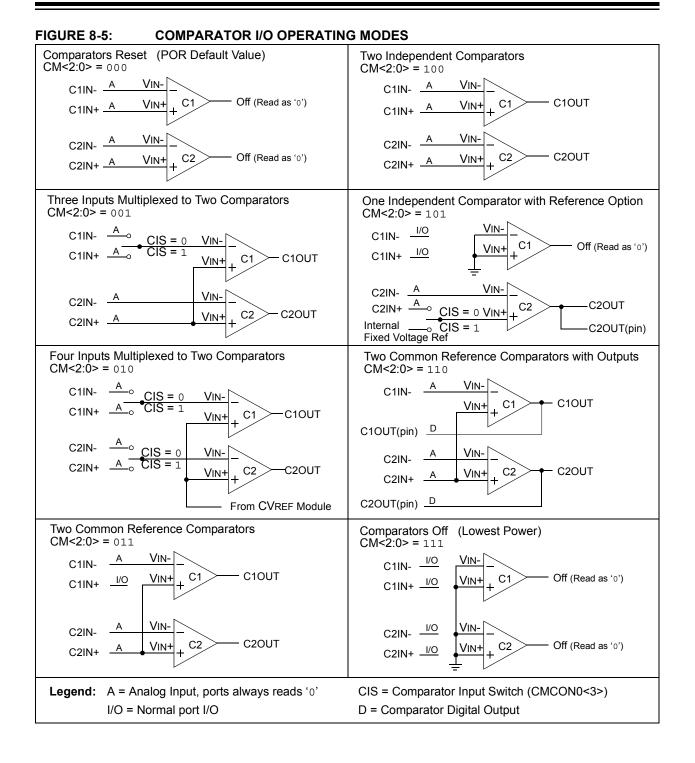
Note 1: Other (non Power-up) Resets include MCLR Reset and Watchdog Timer Reset during normal operation.

2: See Configuration Word register (CONFIG) for operation of all register bits.

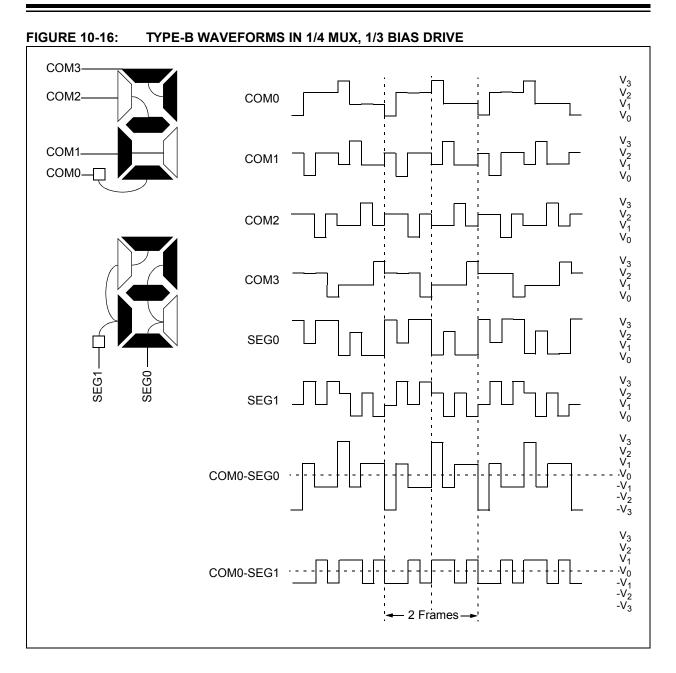
TABLE 6-1:	SUMMARY OF REGISTERS ASSOCIATED WITH TIMER1
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Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
CMCON1	—	_	_	—	_		T1GSS	C2SYNC	10	10
INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000x
PIE1	EEIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
PIR1	EEIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register									uuuu uuuu
TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
T1CON	T1GINV	TMR1GE	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	0000 0000	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.



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Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
CMCON0	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0000	0000 0000
INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000x
LCDCON	LCDEN	SLPEN	WERR	VLCDEN	CS1	CS0	LMUX1	LMUX0	0001 0011	0001 0011
LCDDATA0	SEG7 COM0	SEG6 COM0	SEG5 COM0	SEG4 COM0	SEG3 COM0	SEG2 COM0	SEG1 COM0	SEG0 COM0	XXXX XXXX	uuuu uuuu
LCDDATA1	SEG15 COM0	SEG14 COM0	SEG13 COM0	SEG12 COM0	SEG11 COM0	SEG10 COM0	SEG9 COM0	SEG8 COM0	XXXX XXXX	uuuu uuuu
LCDDATA2 ⁽²⁾	SEG23 COM0	SEG22 COM0	SEG21 COM0	SEG20 COM0	SEG19 COM0	SEG18 COM0	SEG17 COM0	SEG16 COM0	xxxx xxxx	uuuu uuuu
LCDDATA3	SEG7 COM1	SEG6 COM1	SEG5 COM1	SEG4 COM1	SEG3 COM1	SEG2 COM1	SEG1 COM1	SEG0 COM1	xxxx xxxx	uuuu uuuu
LCDDATA4	SEG15 COM1	SEG14 COM1	SEG13 COM1	SEG12 COM1	SEG11 COM1	SEG10 COM1	SEG9 COM1	SEG8 COM1	xxxx xxxx	uuuu uuuu
LCDDATA5 ⁽²⁾	SEG23 COM1	SEG22 COM1	SEG21 COM1	SEG20 COM1	SEG19 COM1	SEG18 COM1	SEG17 COM1	SEG16 COM1	xxxx xxxx	uuuu uuuu
LCDDATA6	SEG7 COM2	SEG6 COM2	SEG5 COM2	SEG4 COM2	SEG3 COM2	SEG2 COM2	SEG1 COM2	SEG0 COM2	xxxx xxxx	uuuu uuuu
LCDDATA7	SEG15 COM2	SEG14 COM2	SEG13 COM2	SEG12 COM2	SEG11 COM2	SEG10 COM2	SEG9 COM2	SEG8 COM2	XXXX XXXX	uuuu uuuu
LCDDATA8 ⁽²⁾	SEG23 COM2	SEG22 COM2	SEG21 COM2	SEG20 COM2	SEG19 COM2	SEG18 COM2	SEG17 COM2	SEG16 COM2	XXXX XXXX	uuuu uuuu
LCDDATA9	SEG7 COM3	SEG6 COM3	SEG5 COM3	SEG4 COM3	SEG3 COM3	SEG2 COM3	SEG1 COM3	SEG0 COM3	XXXX XXXX	uuuu uuuu
LCDDATA10	SEG15 COM3	SEG14 COM3	SEG13 COM3	SEG12 COM3	SEG11 COM3	SEG10 COM3	SEG9 COM3	SEG8 COM3	XXXX XXXX	uuuu uuuu
LCDDATA11 ⁽²⁾	SEG23 COM3	SEG22 COM3	SEG21 COM3	SEG20 COM3	SEG19 COM3	SEG18 COM3	SEG17 COM3	SEG16 COM3	XXXX XXXX	uuuu uuuu
LCDDATA12 ⁽³⁾	SEG31 COM0	SEG30 COM0	SEG29 COM0	SEG28 COM0	SEG27 COM0	SEG26 COM0	SEG25 COM0	SEG24 COM0	XXXX XXXX	uuuu uuuu
LCDDATA13 ⁽³⁾	SEG39 COM0	SEG38 COM0	SEG37 COM0	SEG36 COM0	SEG35 COM0	SEG34 COM0	SE33 COM0	SEG32 COM0	XXXX XXXX	uuuu uuuu
LCDDATA14 ⁽³⁾	—	_	—	—	_	—	SEG41 COM0	SEG40 COM0	xx	uu
LCDDATA15 ⁽³⁾	SEG31 COM1	SEG30 COM1	SEG29 COM1	SEG28 COM1	SEG27 COM1	SEG26 COM1	SEG25 COM1	SEG24 COM1	xxxx xxxx	uuuu uuuu
LCDDATA16 ⁽³⁾	SEG39 COM1	SEG38 COM1	SEG37 COM1	SEG36 COM1	SEG35 COM1	SEG34 COM1	SEG33 COM1	SEG32 COM1	XXXX XXXX	uuuu uuuu
LCDDATA17 ⁽³⁾	—	—	—	—	—	—	SEG41 COM1	SEG40 COM1	xx	uu
LCDDATA18 ⁽³⁾	SEG31 COM2	SEG30 COM2	SEG29 COM2	SEG28 COM2	SEG27 COM2	SEG26 COM2	SEG25 COM2	SEG24 COM2	XXXX XXXX	uuuu uuuu
LCDDATA19 ⁽³⁾	SEG39 COM2	SEG38 COM2	SEG37 COM2	SEG36 COM2	SEG35 COM2	SEG34 COM2	SEG33 COM2	SEG32 COM2	xxxx xxxx	uuuu uuuu
LCDDATA20 ⁽³⁾	_	—	_	—	_	—	SEG41 COM2	SEG40 COM2	xx	uu
LCDDATA21 ⁽³⁾	SEG31 COM3	SEG30 COM3	SEG29 COM3	SEG28 COM3	SEG27 COM3	SEG26 COM3	SEG25 COM3	SEG24 COM3	XXXX XXXX	uuuu uuuu
LCDDATA22 ⁽³⁾	SEG39 COM3	SEG38 COM3	SEG37 COM3	SEG36 COM3	SEG35 COM3	SEG34 COM3	SEG33 COM3	SEG32 COM3	xxxx xxxx	uuuu uuuu
LCDDATA23 ⁽³⁾	—	—	—	—	—	—	SEG41 COM3	SEG40 COM3	xx	uu
LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	0000 0000	0000 0000
LCDSE0	SE7	SE6	SE5	SE4	SE3	SE2	SE1	SE0	0000 0000	uuuu uuuu
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE9	SE8	0000 0000	uuuu uuuu

x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the LCD module. These pins may be configured as port pins, depending on the oscillator mode selected. PIC16F914/917 and PIC16F946 only. PIC16F946 only. Legend:

Note 1:

2: 3:

14.5 Master Mode

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2, Figure 14-2) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and Status bits appropriately set). This could be useful in receiver applications as a Line Activity Monitor mode. The clock polarity is selected by appropriately programming the CKP bit of the SSPCON register. This then, would give waveforms for SPI communication as shown in Figure 14-3, Figure 14-5 and Figure 14-6, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 20 MHz) of 5 Mbps.

Figure 14-3 shows the waveforms for Master mode. When the CKE bit is set, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

Write to SSPBUF SCK (CKP = 0 $\dot{C}KE = 0$) SCK (CKP = 1 $\dot{C}KE = 0$ 4 Clock Modes SCK (CKP = 0)ČKE = 1) SCK (CKP = 1 CKE = 1) SDO bit 6 bit 5 bit 4 bit 2 bit 1 bit 0 bit 7 bit 3 (CKE = 0)SDO bit 6 bit 5 bit 4 bit 2 bit 1 bit 0 bit 7 bit 3 (CKE = 1) SDI (SMP = 0)hit 7 bit 0 Input Sample $(SM\dot{P} = 0)$ SDI (SMP = 1) bit 7 bit 0 Input Sample (SMP = 1)I SSPIF Next Q4 Cycle SSPSR to after Q2↓ SSPBUF

FIGURE 14-3: SPI MODE WAVEFORM (MASTER MODE)

14.12.1 ADDRESSING

Once the SSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPADD <7:1> is compared to the value of register SSPADD <7:1>. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- a) The SSPSR register value is loaded into the SSPBUF register.
- b) The buffer full bit, BF is set.
- c) An ACK pulse is generated.
- d) SSP interrupt flag bit, SSPIF of the PIR1 register is set (interrupt is generated if enabled) on the falling edge of the ninth SCL pulse.

In 10-bit Address mode, two address bytes need to be received by the slave (Figure 14-8). The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address.

The sequence of events for 10-bit address is as follows, with steps 7-9 for slave-transmitter:

- 1. Receive first (high) byte of address (bits SSPIF, BF and bit UA (SSPSTAT<1>) are set).
- Update the SSPADD register with second (low) byte of address (clears bit UA and releases the SCL line).
- 3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 4. Receive second (low) byte of address (bits SSPIF, BF and UA are set).
- 5. Update the SSPADD register with the first (high) byte of address; if match releases SCL line, this will clear bit UA.
- 6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 7. Receive repeated Start condition.
- 8. Receive first (high) byte of address (bits SSPIF and BF are set).
- 9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

TABLE 14-3: DATA TRANSFER RECEIVED BYTE ACTIONS

Status Bits as Data Transfer is Received		$SSPSR \to SSPBUF$	Generate ACK Pulse	Set bit SSPIF (SSP Interrupt occurs	
BF	SSPOV		Fuise	if enabled)	
0	0	Yes	Yes	Yes	
1	0	No	No	Yes	
1	1	No	No	Yes	
0	1	No	No	Yes	

Note: Shaded cells show the conditions where the user software did not properly clear the overflow condition.

ADDLW	Add literal and W				
Syntax:	[<i>label</i>] ADDLW k				
Operands:	$0 \le k \le 255$				
Operation:	$(W) + k \to (W)$				
Status Affected:	C, DC, Z				
Description:	The contents of the W register are added to the eight-bit literal 'k' and the result is placed in the W register.				

BCF	Bit Clear f
Syntax:	[<i>label</i>]BCF f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	0 → (f)
Status Affected:	None
Description:	Bit 'b' in register 'f' is cleared.

ADDWF	Add W and f					
Syntax:	[<i>label</i>] ADDWF f,d					
Operands:	$0 \le f \le 127$ $d \in [0,1]$					
Operation:	(W) + (f) \rightarrow (destination)					
Status Affected:	C, DC, Z					
Description:	Add the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.					

BSF	Bit Set f
Syntax:	[<i>label</i>]BSF f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	$1 \rightarrow (f \le b >)$
Status Affected:	None
Description:	Bit 'b' in register 'f' is set.

ANDLW	AND literal with W				
Syntax:	[<i>label</i>] ANDLW k				
Operands:	$0 \le k \le 255$				
Operation:	(W) .AND. (k) \rightarrow (W)				
Status Affected:	Z				
Description:	The contents of W register are AND'ed with the eight-bit literal 'k'. The result is placed in the W register.				

	register.			
ANDWF	AND W with f			
Syntax:	[<i>label</i>] ANDWF f,d			
Operands:	$0 \le f \le 127$ $d \in [0,1]$			
Operation:	(W) .AND. (f) \rightarrow (destination)			
Status Affected:	Z			
Description:	AND the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the			

result is stored back in register 'f'.

BTFSC	Bit Test f, Skip if Clear				
Syntax:	[<i>label</i>]BTFSC f,b				
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$				
Operation:	skip if (f) = 0				
Status Affected:	None				
Description:	If bit 'b' in register 'f' is '1', the next instruction is executed. If bit 'b', in register 'f', is '0', the next instruction is discarded, and a NOP is executed instead, making this a 2-cycle instruction.				

NOTES:

PIC16F913/914/916/917/946-I (Industrial) 19.5 **DC Characteristics:** PIC16F913/914/916/917/946-E (Extended) (Continued)

DC CHARACTERISTICS		$\begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for extended} \end{array}$					
Param No. Sym. Characteristic		Characteristic	Min.	Typ†	Max.	Units	Conditions
		Capacitive Loading Specs on Output Pins					
D101*	COSC2	OSC2 pin	_	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1
D101A*	Сю	All I/O pins	—	_	50	pF	
		Data EEPROM Memory					
D120	ED	Byte Endurance	100K	1M	_	E/W	$-40^{\circ}C \le TA \le +85^{\circ}C$
D120A	ED	Byte Endurance	10K	100K	—	E/W	$+85^{\circ}C \le TA \le +125^{\circ}C$
D121	Vdrw	VDD for Read/Write	VMIN	—	5.5	V	Using EECON1 to read/write VMIN = Minimum operating voltage
D122	TDEW	Erase/Write Cycle Time	_	5	6	ms	
D123	TRETD	Characteristic Retention	40	_	—	Year	Provided no other specifications are violated
D124	TREF	Number of Total Erase/Write Cycles before Refresh ⁽⁴⁾	1M	10M	—	E/W	$-40^{\circ}C \le TA \le +85^{\circ}C$
		Program Flash Memory					
D130	Eр	Cell Endurance	10K	100K	—	E/W	$-40^{\circ}C \le TA \le +85^{\circ}C$
D130A	ED	Cell Endurance	1K	10K	_	E/W	+85°C ≤ TA ≤ +125°C
D131	Vpr	VDD for Read	Vmin	-	5.5	V	VMIN = Minimum operating voltage
D132	VPEW	VDD for Erase/Write	4.5	—	5.5	V	
D133	TPEW	Erase/Write cycle time	—	—	3	ms	
D134	TRETD	Characteristic Retention	40	-	—	Year	Provided no other specifications are violated

These parameters are characterized but not tested.

t Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended to use an external clock in RC mode.

2: Negative current is defined as current sourced by the pin.

3: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

4: See Section 13.0 "Data EEPROM and Flash Program Memory Control" for additional information.

5: Including OSC2 in CLKOUT mode.

DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Sym.	Characteristic		Min.	Тур†	Max. (85°C)	Max. (125°C)	Units	Conditions
VPLVD	PLVD Voltage	LVDL<2:0> = 001	1.900	2.0	2.100	2.125	V	
		LVDL<2:0> = 010	2.000	2.1	2.200	2.225	V	
		LVDL<2:0> = 011	2.100	2.2	2.300	2.325	V	
		LVDL<2:0> = 100	2.200	2.3	2.400	2.425	V	
		LVDL<2:0> = 101	3.825	4.0	4.175	4.200	V	
		LVDL<2:0> = 110	4.025	4.2	4.375	4.400	V	
		LVDL<2:0> = 111	4.425	4.5	4.675	4.700	V	
*TPLVDS	PLVD Settling time		—	50 25			μs	VDD = 5.0V VDD = 3.0V

TABLE 19-13: PIC16F913/914/916/917/946 PLVD CHARACTERISTICS:

* These parameters are characterized but not tested

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

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